

SF5A05 THRU SF5A60

List

List.....	1
Package outline.....	2
Features.....	2
Mechanical data.....	2
Maximum ratings	2
Rating and characteristic curves.....	3
Pinning information.....	4
Marking.....	4
Tube packing.....	4
Suggested thermal profiles for soldering processes.....	5
High reliability test capabilities.....	6

SF5A05 THRU SF5A60

5.0A Super Fast Recovery Rectifiers - 50V-600V

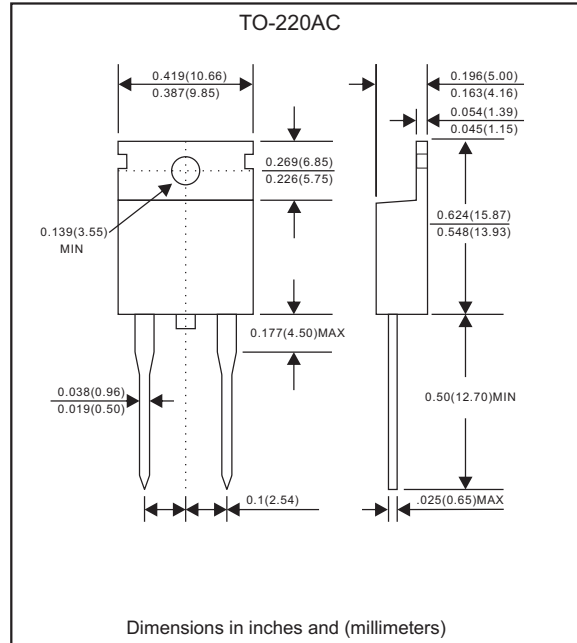
Features

- Low forward voltage, high current capability
- High surge current capability.
- Super fast recovery time for switching mode application.
- Low power loss.
- Glass passivated chip junctions.
- Lead-free parts meet environmental standards of MIL-STD-19500/228
- Suffix "-H" indicates Halogen-free parts, ex. SF5A05-H.

Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : JEDEC TO-220AC molded plastic body over passivated chip
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guaranteed
- Polarity: As marked
- Mounting Position : Any
- Weight : Approximated 2.05 gram

Package outline



Maximum ratings (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOLS	SF5A05	SF5A10	SF5A20	SF5A40	SF5A60	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	V
Maximum average forward rectified current	I_o	5					A
Peak forward surge current 8.3ms single half sine-wave(JEDEC method)	I_{FSM}	100					A
Operating junction temperature range	T_J	-55 to +150					$^{\circ}\text{C}$
Storage temperature range	T_{STG}	-65 to +175					$^{\circ}\text{C}$

Electrical Characteristics (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOLS	SF5A05	SF5A10	SF5A20	SF5A40	SF5A60	UNIT
Maximum forward voltage at $I_F=5A$	V_F	0.98			1.30	1.85	V
Maximum DC reverse current at rated DC blocking voltage	I_R				5.0 200		μA μA
Maximum reverse recovery time (Note 1)	t_{rr}				35		ns

Thermal Characteristics

PARAMETER	SYMBOLS	SF5A05	SF5A10	SF5A20	SF5A40	SF5A60	UNIT
Typical thermal resistance junction to case	$R_{\theta JC}$				2.5		$^{\circ}\text{C}/\text{W}$

Note 1: Reverse recovery time test condition, $I_F=0.5A$, $I_R=1.0A$, $I_{RR}=0.25A$

Rating and characteristic curves (SF5A05 THRU SF5A60)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

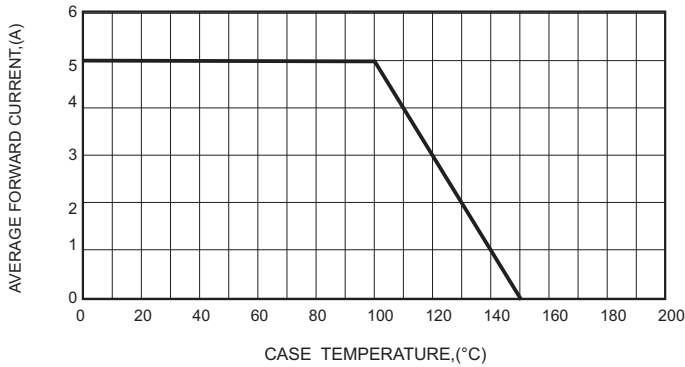


FIG.2-TYPICAL FORWARD CHARACTERISTICS

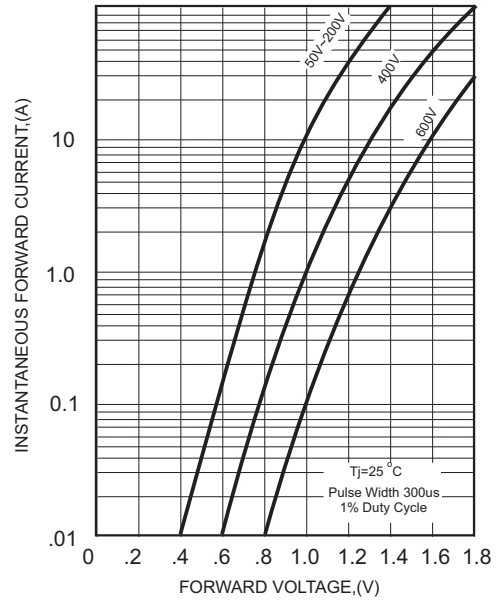


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

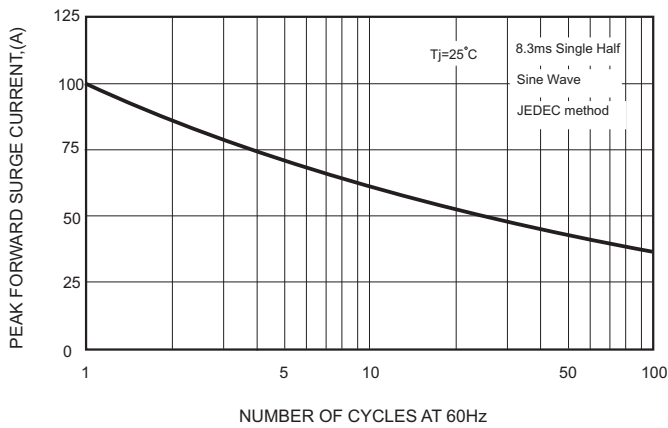


FIG.4 - TYPICAL REVERSE CHARACTERISTICS

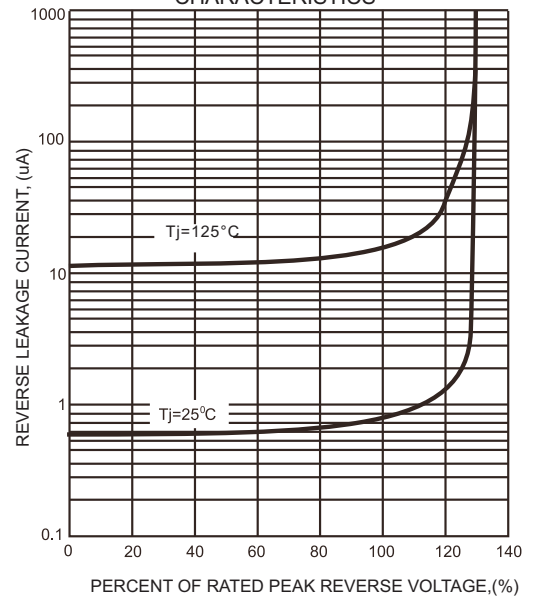
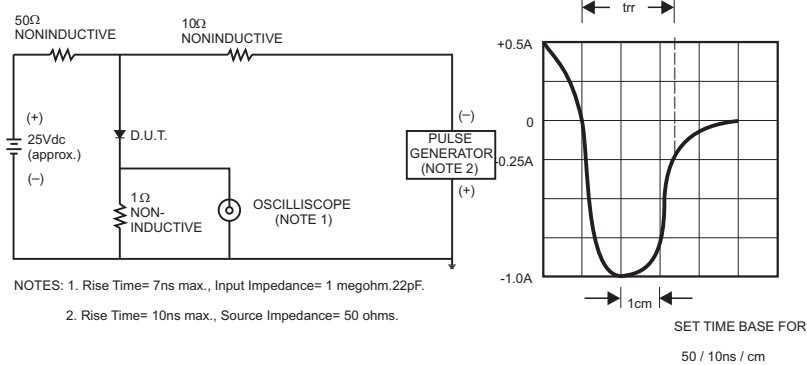


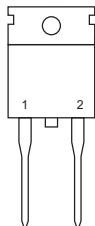

FIG.5- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm, 22pF.
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

SF5A05 THRU SF5A60

Pinning information

Pin	Simplified outline	Symbol
Pin1 cathode Pin2 anode		

Marking

Type number	Marking code
SF5A05	SF5A05
SF5A10	SF5A10
SF5A20	SF5A20
SF5A40	SF5A40
SF5A60	SF5A60

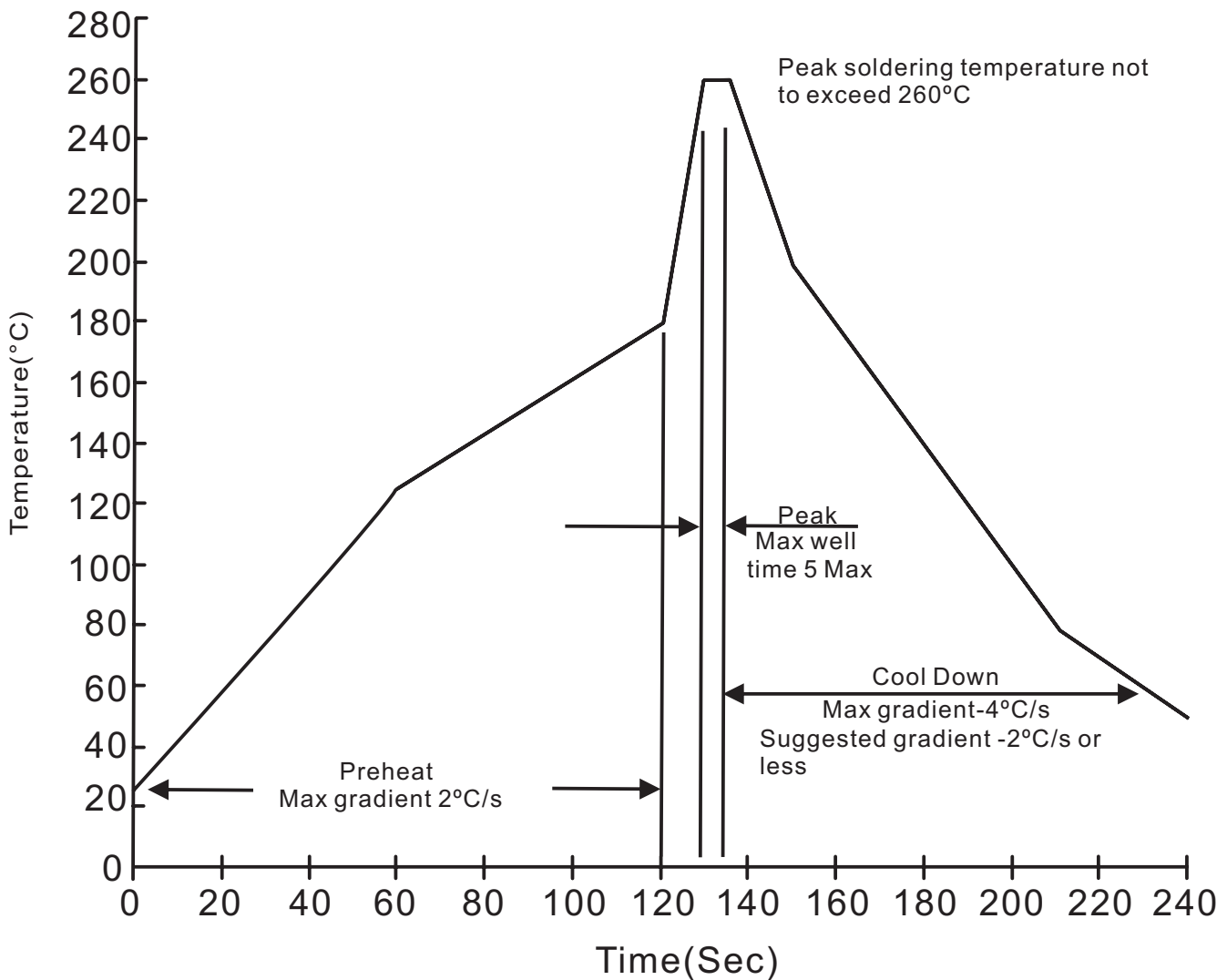
Tube packing

PACKAGE	TUBE (pcs)	TUBE SIZE (m/m)	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
TO-220AC	50	525*32*7.5	1000	555*150*40	580*230*175	5,000	15.0

SF5A05 THRU SF5A60

Suggested thermal profiles for soldering processes

1. Lead free temperature profile wave-soldering



SF5A05 THRU SF5A60

High reliability test capabilities

Item Test	Conditions	Reference
1. Solder Resistance	at $260\pm 5^{\circ}\text{C}$ for $10\pm 2\text{sec}$. immerse body into solder $1/16''\pm 1/32''$	MIL-STD-750D METHOD-2031
2. Solderability	at $245\pm 5^{\circ}\text{C}$ for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	$V_R=80\%$ rate at $T_J=150^{\circ}\text{C}$ for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at $T_A=25^{\circ}\text{C}$ for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	$T_A = 25^{\circ}\text{C}$, $I_F = I_O$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	$15P_{SIG}$ at $T_A=121^{\circ}\text{C}$ for 4 hrs.	JESD22-A102
7. Temperature Cycling	-55°C to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Forward Surge	8.3ms single half sine-wave , one surge.	MIL-STD-750D METHOD-4066-2
9. Humidity	at $T_A=85^{\circ}\text{C}$, RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
10. High Temperature Storage Life	at 175°C for 1000 hrs.	MIL-STD-750D METHOD-1031